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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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HAT3010R

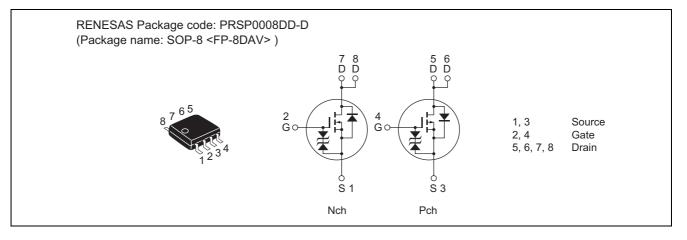
Silicon N / P Channel Power MOS FET High Speed Power Switching

> REJ03G1199-1000 (Previous: ADE-208-1402H) Rev.10.00 Sep 07, 2005

Features

- Low on-resistance
- Capable of 4.5 V gate drive
- High density mounting

Outline





Absolute Maximum Ratings

$(Ta = 25^{\circ}C)$

ltem	Symbol	Va	Unit		
item	Symbol	Nch	Pch	Unit	
Drain to source voltage	V _{DSS}	60	-60	V	
Gate to source voltage	V _{GSS}	±20	±20	V	
Drain current	I _D	6	-5	А	
Drain peak current	I _{D (pulse)} Note 1	48	-40	А	
Body-drain diode reverse drain current	I _{DR}	6	-5	А	
Channel dissipation	Pch Note 2	2	2	W	
Channel dissipation	Pch Note 3	3	3	W	
Channel temperature	Tch	150	150	°C	
Storage temperature	Tstg	-55 to +150	–55 to +150	°C	

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. 1 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

3. 2 Drive operation: When using the glass epoxy board (FR4 40 \times 40 \times 1.6 mm), PW \leq 10 s

Electrical Characteristics

N Channel

						(Ta = 25°C)
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	60	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	1	μA	$V_{DS} = 60 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0	—	2.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	—	25	32	mΩ	$I_D = 3 \text{ A}, V_{GS} = 10 \text{ V}^{Note 4}$
	R _{DS (on)}	—	32	45	mΩ	$I_D = 3 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note 4}$
Forward transfer admittance	y _{fs}	7	11	—	S	$I_D = 3 \text{ A}, V_{DS} = 10 \text{ V}^{Note 4}$
Input capacitance	Ciss	—	1050	—	pF	V _{DS} = 10 V
Output capacitance	Coss	—	150	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	90		pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	—	15	_	ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$
Rise time	tr	—	15	—	ns	$V_{DD}\cong 30~V$
Turn-off delay time	t _{d (off)}	—	55		ns	$R_L = 10 \Omega$
Fall time	t _f	—	10		ns	Rg = 4.7 Ω
Body-drain diode forward voltage	V _{DF}	—	0.85	1.10	V	$I_F = 6 A, V_{GS} = 0^{Note 4}$
Body-drain diode reverse recovery time	t _{rr}	—	50	_	ns	$I_F = 6 A, V_{GS} = 0$
						di _F /dt = 100 A/µs

Note: 4. Pulse test

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HAT3010R

P Channel

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(Ta = 25^{\circ}C)
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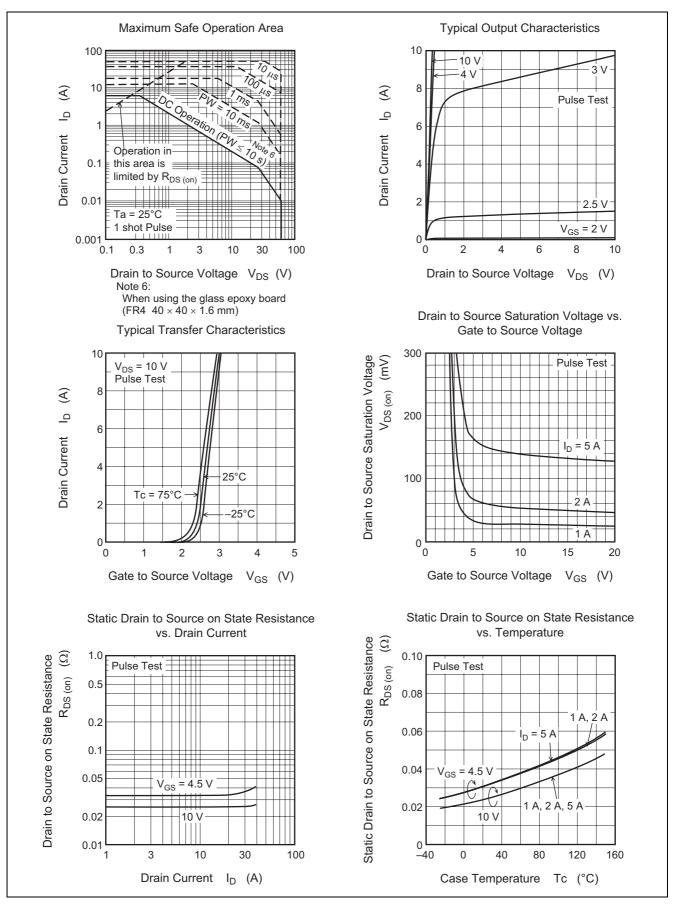
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	-60		_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20			V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—		±10	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—		-1	μA	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	-1.0		-2.5	V	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$
Static drain to source on state resistance	R _{DS (on)}	—	60	76	mΩ	$I_D = -2.5 \text{ A}, V_{GS} = -10 \text{ V}^{\text{Note 5}}$
	R _{DS (on)}	—	90	130	mΩ	$I_D = -2.5 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note 5}}$
Forward transfer admittance	y _{fs}	3	5	—	S	$I_D = -2.5 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note 5}}$
Input capacitance	Ciss	_	1350	—	pF	$V_{DS} = -10 V$
Output capacitance	Coss	_	135	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	85	—	pF	f = 1 MHz
Turn-on delay time	t _{d (on)}	_	20	—	ns	$V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$
Rise time	tr	_	15	—	ns	$V_{DD} \cong -30 \text{ V}$
Turn-off delay time	t _{d (off)}	—	55	_	ns	R _L = 12 Ω
Fall time	t _f	—	10	_	ns	Rg = 4.7 Ω
Body-drain diode forward voltage	V _{DF}		-0.85	-1.10	V	$I_F = -5 \text{ A}, V_{GS} = 0^{\text{Note 5}}$
Body-drain diode reverse recovery time	t _{rr}	—	50	_	ns	$I_F = -5 A, V_{GS} = 0$
						di _F /dt = 100 A/µs

Note: 5. Pulse test

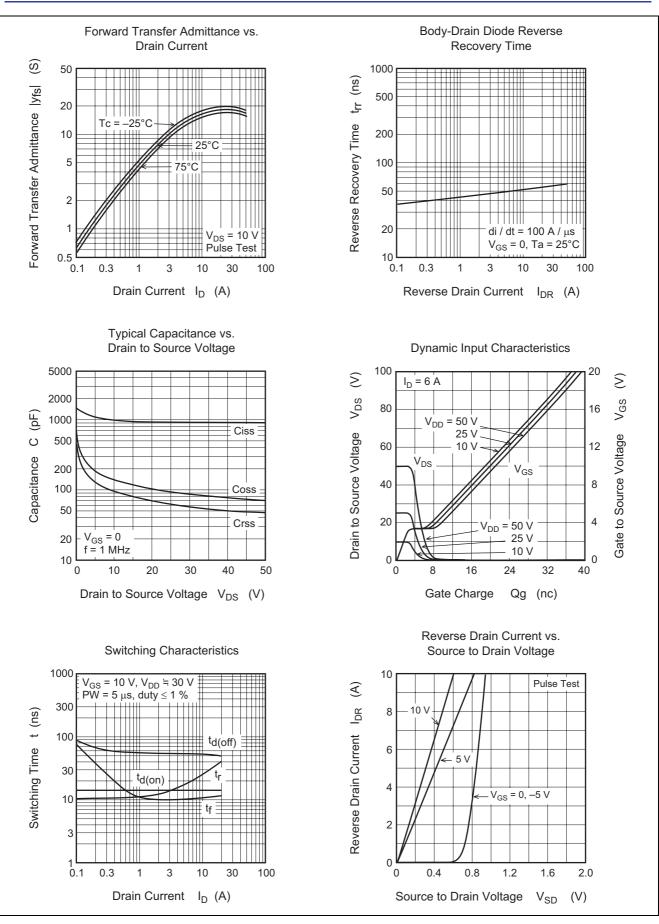


Main Characteristics

N Channel

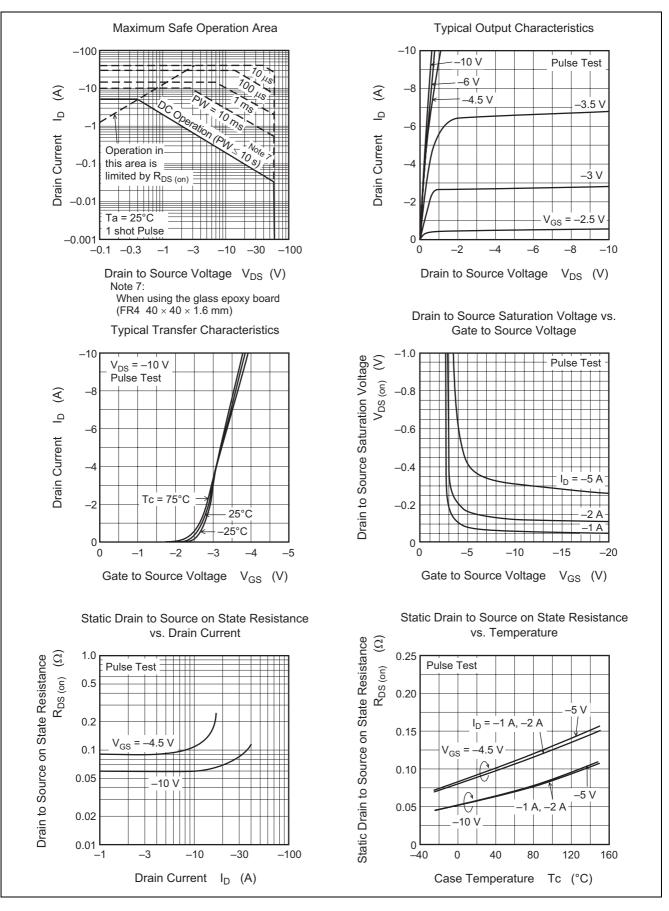




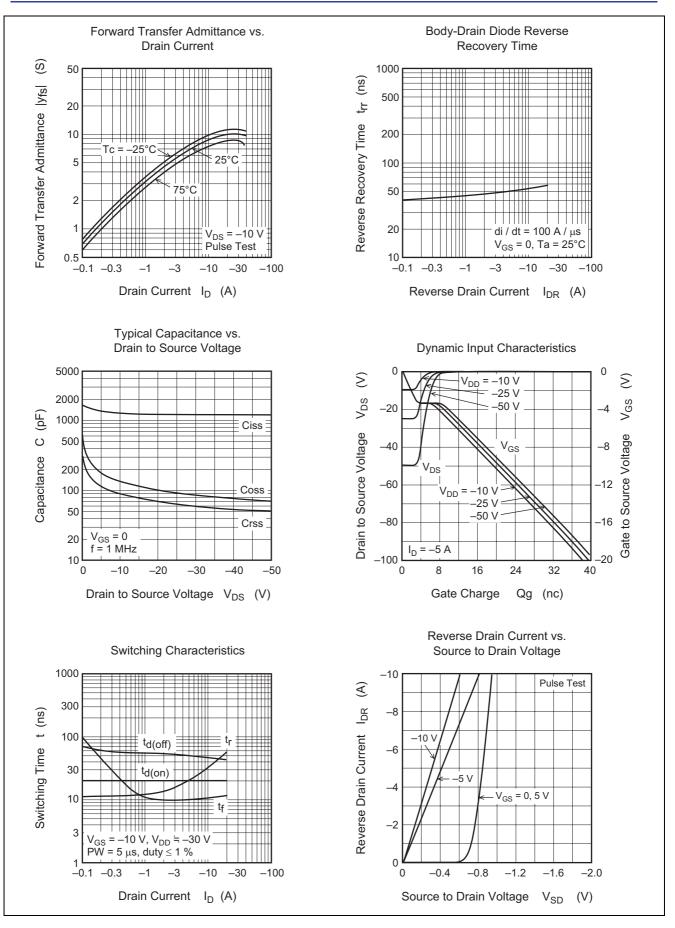




P Channel

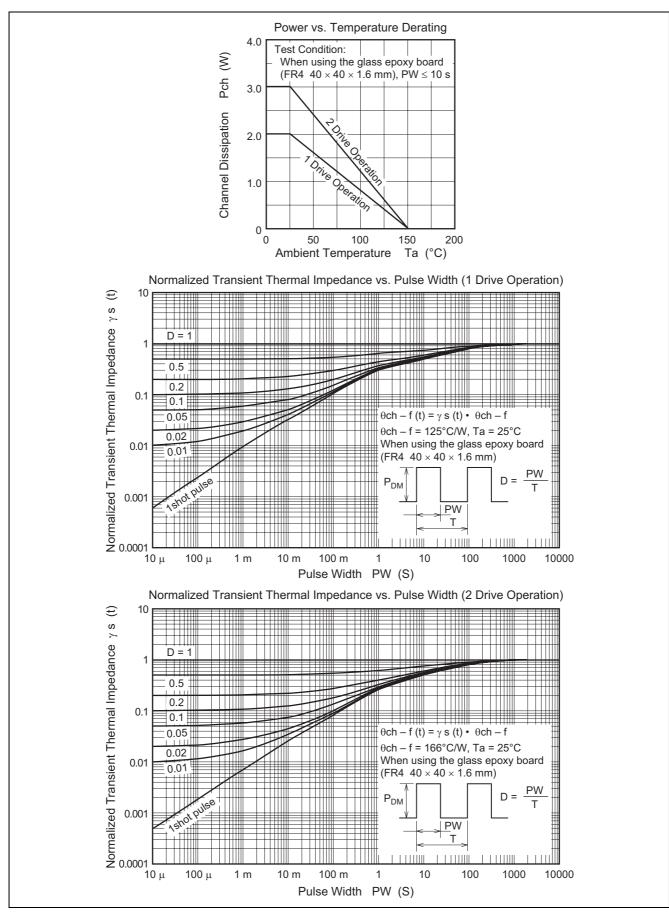






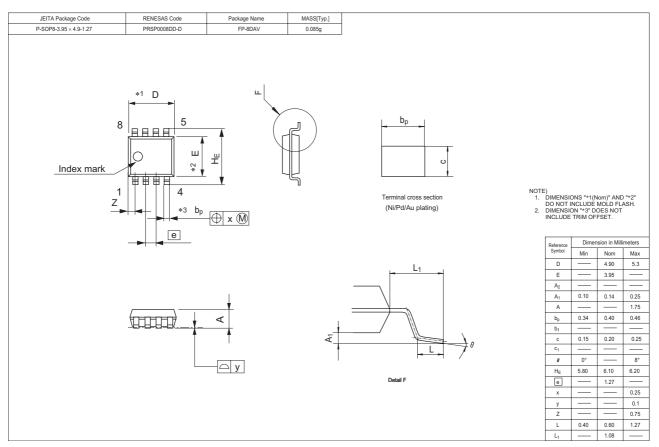


Common





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT3010R-EL-E	2500 pcs	Taping

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Renesas Technology Malaysia Sdn. Bhd.

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